

Description

The HFDMC6675BZ uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge .Thisdevice is well suited for high currentload applications.

General Features

 $V_{DS} = -30V, I_{D} = -32A$

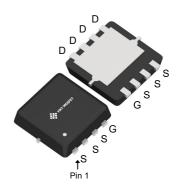
 $R_{DS(ON)}$ <12m Ω @ V_{GS} =-10V

 $R_{DS(ON)}$ <18m Ω @ V_{GS} =-4.5V

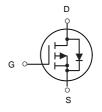
Application

High side switch for full bridge converter

DC/DC converter for LCD display



DFN3X3-8L



P-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
HFDMC6675BZ	DFN3X3-8L	HXY MOSFET	5000

Absolute Maximum Ratings@Tj=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	-30	V
VGS	Gate-Source Voltage	±25	V
ID@TA=25°C	Drain Current, V _{GS} @ 10V	-32	Α
I _D @T _A =70°C	Drain Current, V _{GS} @ 10V	-9.8	Α
IDM	Pulsed Drain Current ¹	-65	Α
P _D @T _A =25°C	Total Power Dissipation	3.57	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Rthj-c	Maximum Thermal Resistance, Junction-case	6	°C/W
Rthj-a	Maximum Thermal Resistance, Junction- ambient ³	35	°C/W



Electrical Characteristics@Tj=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250uA	-30	-	-	V
` '	Static Drain-Source On-	V _{GS} =-10V, I _D =-15A	-	10	12	mΩ
	Resistance ²	V _{GS} =-4.5V, I _D =-10A	-	14	18	mΩ
VGS(th)	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250uA	-1	-1.95	-2.5	V
g fs	Forward Transconductance	V _{DS} =-10V, I _D =-6A	-	19	-	S
IDSS	Drain-Source Leakage Current	V _{DS} =-24V, V _{GS} =0V	-	-	-30	uA
IGSS	Gate-Source Leakage	V _{GS} = <u>+</u> 20V, V _{DS} =0V	-	-	<u>+</u> 100	nA
Qg	Total Gate Charge	I _D =-15A	-	12.5	24	nC
Q _{gs}	Gate-Source Charge	V _{DS} =-15V	-	5.4	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	V _{GS} =-4.5V	-	5	-	nC
td(on)	Turn-on Delay Time	V _{DS} =-15V	-	4.4	-	ns
t _r	Rise Time	I _D =-15A	-	11.2	-	ns
td(off)	Turn-off Delay Time	R _G =3.3Ω	-	34	-	ns
t _f	Fall Time	V _{GS} =-10V	-	18	-	ns
Ciss	Input Capacitance	V _{GS} =0V	-	1345	2000	pF
Coss	Output Capacitance	V _{DS} =-15V f=1.0MHz	-	194	-	pF
Crss	Reverse Transfer Capacitance		-	158	-	pF
trr	Reverse Recovery Time	Is=-15A, V _{GS} =0V, dl/dt=100A/µs	-	12.4	-	ns
Q _{rr}	Reverse Recovery Charge		-	5	-	nC

Notes:

^{1.} Pulse width limited by Max. junction temperature.

^{2.}Pulse test



Typical Characteristics

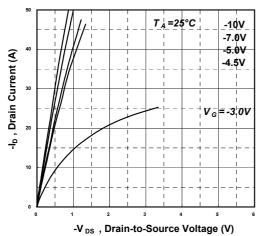


Fig 1. Typical Output Characteristics

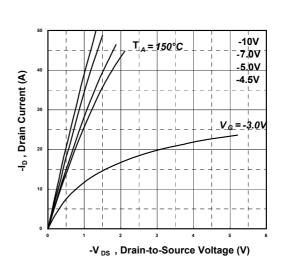


Fig 2. Typical Output Characteristics

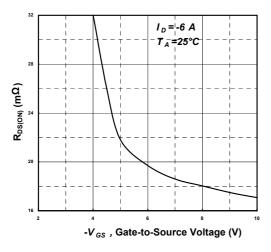


Fig 3. On-Resistance v.s. Gate Voltage

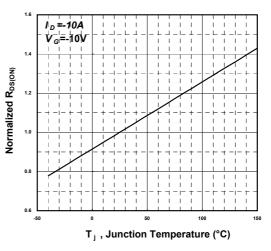


Fig 4. Normalized On-Resistance v.s. Junction Temperature

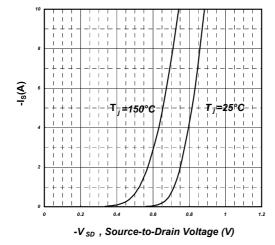


Fig 5. Forward Characteristic of Reverse Diode

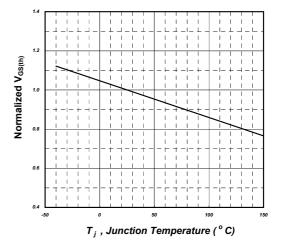


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

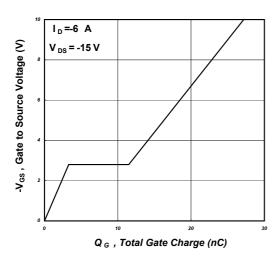


Fig 7. Gate Charge Characteristics

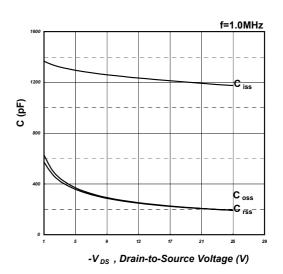
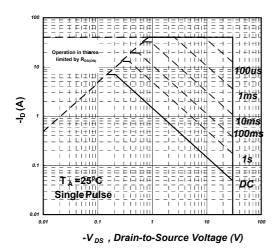


Fig 8. Typical Capacitance Characteristics



0.001 0.001 0.01 0.1 1 100 1000 t , Pulse Width (s)

Fig 9. Maximum Safe Operating Area Fig 10. Effective Transient Thermal Impedance

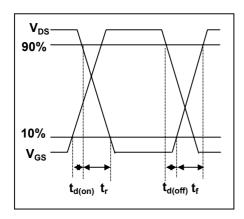


Fig 11. Switching Time Waveform

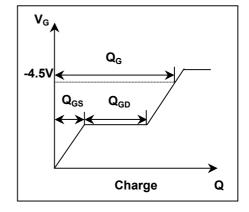
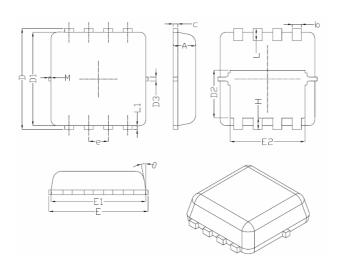


Fig 12. Gate Charge Waveform

DFN3X3-8L Package Information



Complete I	Dimensions In Millimeters			
Symbol	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
С	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.48	1.58	1.68	
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
е	0.65BSC			
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
M	*	*	0.15	
θ		10°	12 [°]	



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